Field Stop Trench IGBT

650 V, 75 A

FGHL75T65MQD

Field stop 4th generation mid speed IGBT technology and Full current rated copak Diode technology.

Features

- Maximum Junction Temperature: $T_J = 175^{\circ}C$
- Positive Temperature Co-efficient for Easy Parallel Operating
- High Current Capability
- Low Saturation Voltage: V_{CE(sat)} = 1.45 V (Typ.) @ I_C = 75 A
- 100% of the Parts are Tested for ILM (Note 2)
- Smooth & Optimized Switching
- Tight Parameter Distribution
- RoHS Compliant

Typical Applications

- Solar Inverter
- UPS, ESS
- PFC, Converters

MAXIMUM RATINGS

Parameter		Symbol	Value	Unit
Collector-to-Emitter Voltage	Collector-to-Emitter Voltage		650	V
Gate-to-Emitter Voltage		V _{GES}	±20	V
Transient Gate-to-Emitter Voltage	•	V _{GES}	±30	V
Collector Current (Note 1)	$T_{C} = 25^{\circ}C$	Ι _C	80	А
	$T_{C} = 100^{\circ}C$		75	
Pulsed Collector Current (Note 2)		I _{LM}	300	А
Pulsed Collector Current (Note 3)		I _{CM}	300	А
Diode Forward Current (Note 1)	$T_{C} = 25^{\circ}C$	١ _F	80	А
	$T_{C} = 65^{\circ}C$		75	
Pulsed Diode Maximum Forward C	Current	I _{FM(2)}	300	А
Non-Repetitive Forward Surge Cu (Half-Sine Pulse, $t_p = 8.3 \text{ ms}$, $T_C = (Half-Sine Pulse, t_p = 8.3 \text{ ms}, T_C = 0.3 \text{ ms}$	I _{F,SM}	255 225	A	
Maximum Power Dissipation	$T_{C} = 25^{\circ}C$	PD	375	W
	$T_{\rm C} = 100^{\circ}{\rm C}$		188	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	–55 to +175	°C
Maximum Lead Temperature for Soldering Purposes (1/8" from case for 5 s)		ΤL	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Value limit by bond wire

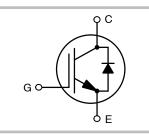
2. V_{CC} = 400 V, V_{GE} = 15 V, I_C = 300 A, R_G = 14 Ω , Inductive Load, 100% Tested 3. Repetitive rating: Pulse width limited by max. junction temperature



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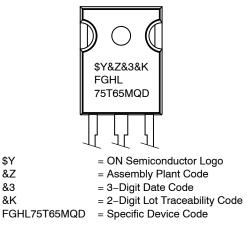
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BV _{CES}	V _{CE(sat)} TYP	I _C MAX
650 V	1.45 V	75 A





MARKING DIAGRAM



ORDERING INFORMATION

Device	Package	Shipping
FGHL75T65MQD	TO-247-3L	30 Units / Rail

Table 1. THERMAL CHARACTERISTICS

Parameter	Symbol	Value	Unit
Thermal Resistance Junction-to-Case, for IGBT	R _{θJC}	0.40	°C/W
Thermal Resistance Junction-to-Case, for Diode	R _{θJC}	0.6	
Thermal Resistance Junction-to-Ambient	R _{θJA}	40	

Table 2. ELECTRICAL CHARACTERISTICS (T_J = $25^{\circ}C$ unless otherwise specified)

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTIC	•				•	
Collector-emitter breakdown voltage, gate-emitter short-circuited	V _{GE} = 0 V, I _C = 1 mA	BV _{CES}	650	-	-	V
Temperature Coefficient of Breakdown Voltage	V _{GE} = 0 V, I _C = 1 mA	$\Delta BV_{CES}/\Delta T_{J}$	-	0.6	-	V/°C
Collector-emitter cut-off current, gate-emitter short-circuited	V _{GE} = 0 V, V _{CE} = 650 V	I _{CES}	-	-	250	μA
Gate leakage current, collector-emit- ter short-circuited	$V_{GE} = 20 \text{ V}, \text{ V}_{CE} = 0 \text{ V}$	I _{GES}	-	-	±400	nA
ON CHARACTERISTIC	•					
Gate-emitter threshold voltage	$V_{GE} = V_{CE}, I_C = 75 \text{ mA}$	V _{GE(th)}	3.0	4.5	6.0	V
Collector-emitter saturation voltage	V_{GE} = 15 V, I _C = 75 A V _{GE} = 15 V, I _C = 75 A, T _J = 175°C	V _{CE(sat)}	-	1.45 1.65	1.8 -	V
DYNAMIC CHARACTERISTIC						-
Input capacitance	V_{CE} = 30 V, V_{GE} = 0 V, f = 1 MHz	C _{ies}	-	4913	-	pF
Output capacitance	7	C _{oes}	-	131	-	
Reverse transfer capacitance	1	C _{res}	-	15	-	
Gate charge total	V_{CE} = 400 V, I _C = 75 A, V _{GE} = 15 V	Qg	-	145	-	nC
Gate-to-Emitter charge	7	Q _{ge}	-	25	-	
Gate-to-Collector charge	7	Q _{gc}	-	33	-	
SWITCHING CHARACTERISTIC, INC	DUCTIVE LOAD					-
Turn-on delay time	$T_{C} = 25^{\circ}C$	t _{d(on)}	-	29	-	ns
Rise time	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 37.5 \text{ A}$ $R_{G} = 10 \Omega$	t _r	-	29	-	
Turn-off delay time	V _{GE} = 15 V Inductive Load	t _{d(off)}	-	193	-	
Fall time	1	t _f	-	47	-	
Turn-on switching loss	1	E _{on}	-	0.75	-	mJ
Turn-off switching loss	1	E _{off}	-	0.48	-	
Total switching loss	1	E _{ts}	-	1.22	-	
Turn-on delay time	$T_{C} = 25^{\circ}C$	t _{d(on)}	-	33	-	ns
Rise time	V_{CC}^{2} = 400 V, I _C = 75 A R _G = 10 Ω V _{GE} = 15 V Inductive Load	t _r	-	60	-	
Turn-off delay time		t _{d(off)}	-	176	-	
Fall time		t _f	-	76	-	
Turn-on switching loss]	E _{on}	-	1.94	-	mJ
Turn-off switching loss]	E _{off}	-	1.55	-	
Total switching loss	7	E _{ts}	-	3.49	-	

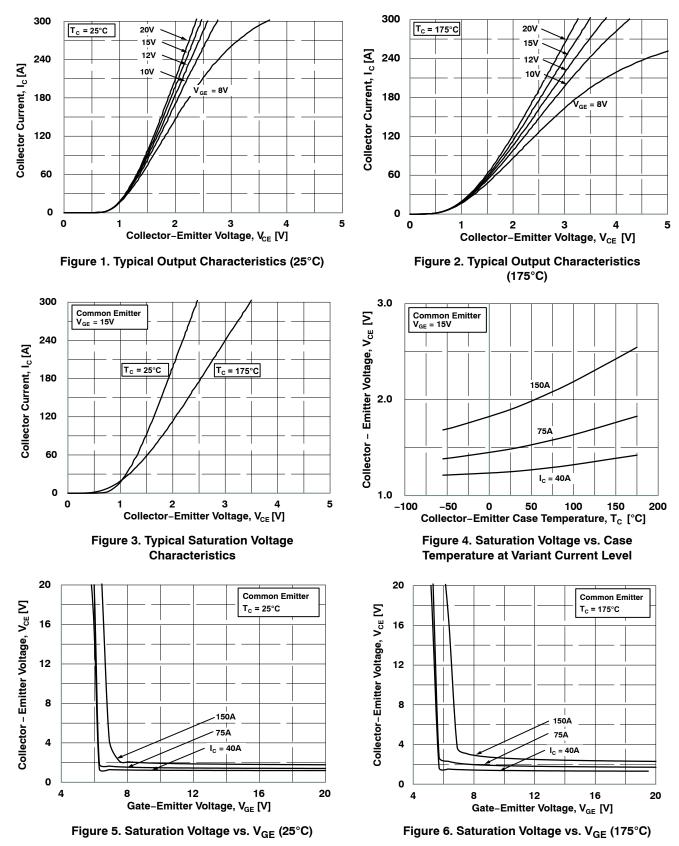
Table 2. ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise specified) (continued)

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
SWITCHING CHARACTERISTI	C, INDUCTIVE LOAD					
Turn-on delay time	$T_{\rm C} = 175^{\circ}{\rm C}$	t _{d(on)}	-	27	-	ns
Rise time	V_{CC} = 400 V, I _C = 37.5 A R _G = 10 Ω	t _r	-	31	-	
Turn-off delay time	V _{GE} = 15 V Inductive Load	t _{d(off)}	-	214	-	
Fall time		t _f	-	66	-	
Turn-on switching loss		E _{on}	-	1.49	-	mJ
Turn-off switching loss		E _{off}	-	0.72	-	
Total switching loss		E _{ts}	-	2.21	-	
Turn-on delay time	$T_{\rm C} = 175^{\circ}{\rm C}$	t _{d(on)}	-	31	-	ns
Rise time	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 75 \text{ A}$ $R_{G} = 10 \Omega$	t _r	-	61	-	
Turn-off delay time	V _{GE} = 15 V Inductive Load	t _{d(off)}	-	191	-	
Fall time		t _f	-	85	-	
Turn-on switching loss		E _{on}	-	3.23	-	mJ
Turn-off switching loss		E _{off}	-	1.90	-	
Total switching loss		E _{ts}	-	5.12	-	1

DIODE CHARACTERISTIC

Diode Forward Voltage	$I_F = 75 \text{ A}, T_C = 25^{\circ}\text{C}$ $I_F = 75 \text{ A}, T_C = 175^{\circ}\text{C}$	V _{FM}	-	2.3 1.9	2.6 -	V
Reverse Recovery Energy	$I_F = 75 \text{ A}, dI_F/dt = 200 \text{ A}/\mu \text{s}, T_C = 175^{\circ}\text{C}$	E _{rec}	-	49	-	μJ
Diode Reverse Recovery Time	$ I_{F} = 75 \text{ A}, \text{ d}I_{F}/\text{d}t = 200 \text{ A}/\mu\text{s}, T_{C} = 25^{\circ}\text{C} \\ I_{F} = 75 \text{ A}, \text{ d}I_{F}/\text{d}t = 200 \text{ A}/\mu\text{s}, T_{C} = 175^{\circ}\text{C} $	T _{rr}	-	36 204	-	ns
Diode Reverse Recovery Charge	$ I_F = 75 \text{ A}, \ dI_F/dt = 200 \text{ A}/\mu \text{s}, \ T_C = 25^\circ \text{C} \\ I_F = 75 \text{ A}, \ dI_F/dt = 200 \text{ A}/\mu \text{s}, \ T_C = 175^\circ \text{C} $	Q _{rr}	-	51 990	-	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.



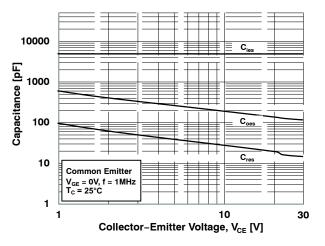
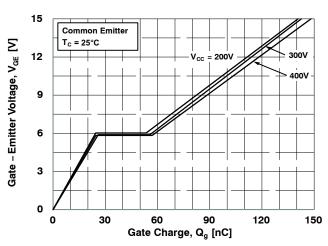
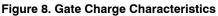
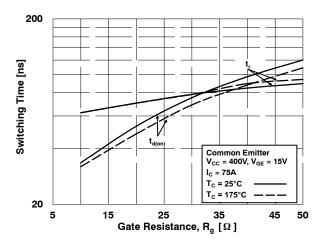


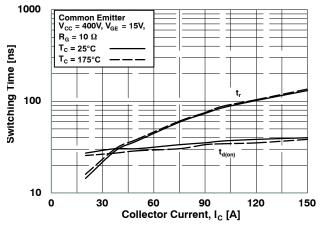
Figure 7. Capacitance Characteristics

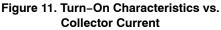


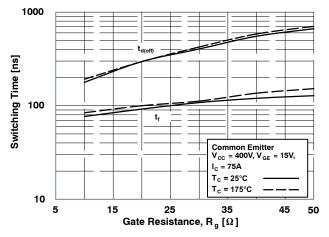




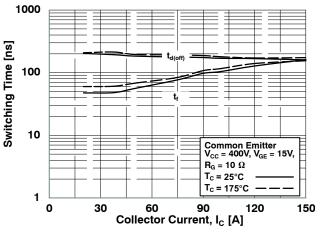


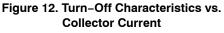












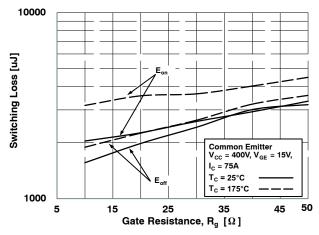
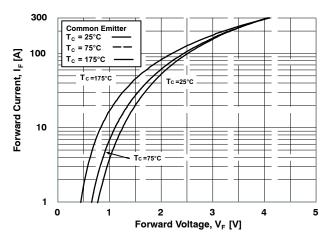
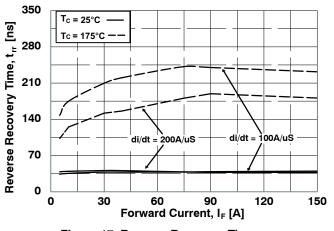
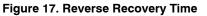


Figure 13. Switching Loss vs. Gate Resistance









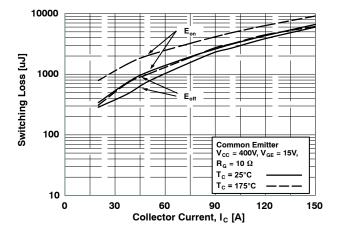
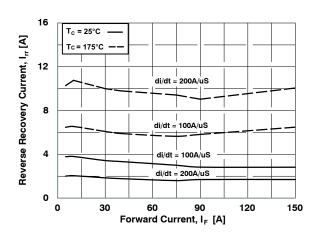
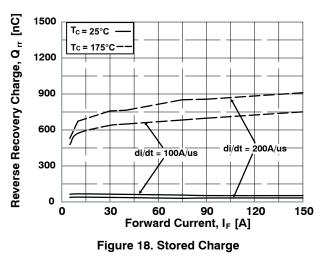


Figure 14. Switching Loss vs. Collector Current







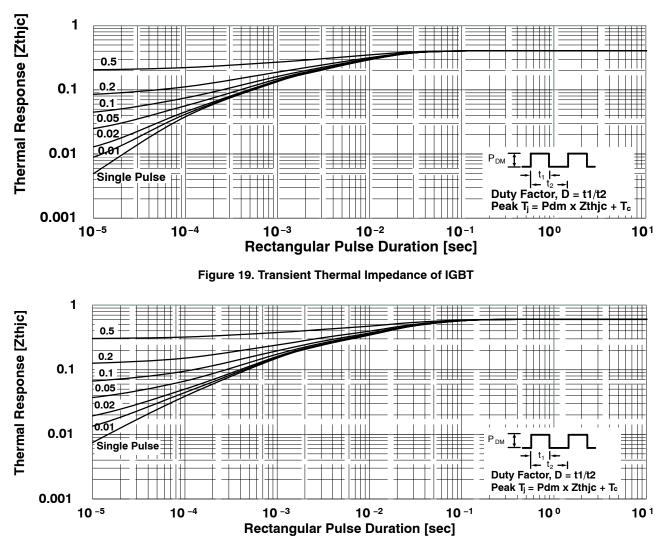
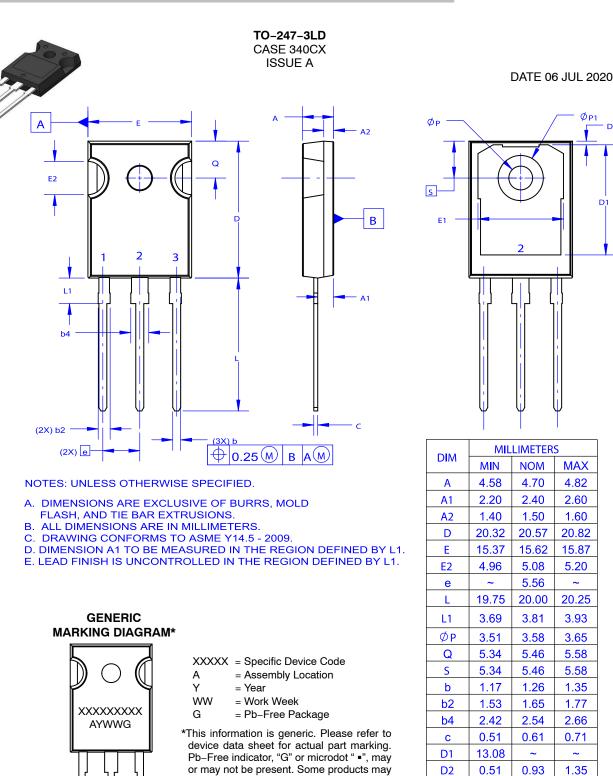


Figure 20. Transient Thermal Impedance of Diode



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